

SOP16, 2.5A Output Smart Gate Driver Optocoupler

Description

The MPCS-332J is an advanced 2.5 A output current, easyto-use, intelligent gate driver which makes IGBT V_{CE} fault protection compact, affordable, and easy-to implement. Features such as integrated V_{CE} detection, under voltage lockout (UVLO), "soft" IGBT turn-off, isolated open collector fault feedback and active Miller clamping provide maximum design flexibility and circuit protection. The MPCS -332J contains a LED. The LED is optically coupled to an integrated circuit with a power output stage. MPCS -332J is ideally suited for driving power IGBTs and MOSFETs used in motor control inverter applications. The voltage and current supplied by these optocouplers make them ideally suited for directly driving IGBTs with ratings up to 1200 V and 150 A. For IGBTs with higher ratings, the MPCS -332J can be used to drive a discrete power stage which drives the IGBT gate. The MPCS -332J has an insulation voltage of VIORM = 1414 VPEAK.

Features

- 2.5 A maximum peak output current
- 2.0 A minimum peak output current
- 250 ns maximum propagation delay over temperature range
- 1.7A Active Miller Clamp. Clamp pin short to
 V_{EE} if not in used
- Miller Clamping
- Desaturation Detection
- Under Voltage Lock-Out Protection (UVLO)
 with Hysteresis
- "Soft" IGBT Turn-off



PIN DEFINITION

1.Vs	16.VE
2.Vcc1	15.VLED
3.FAULT	14.DESAT
4.Vs	13.Vcc2
5.CATHODE	12.V _{EE}
6.ANODE	11.Vout
7.ANODE	10.VCLAMP
8.CATHODE	9.V _{EE}

PACKAGE OUTLINE





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- Fault Reset by next LED turn-on (low to high) after fault mute period
- Available in SO-16 package
- 100 ns maximum pulse width distortion (PWD)
- 50 kV/ μ s minimum common mode rejection (CMR) at V_{CM} = 1500 V
- I_{CC}(max) < 5 mA maximum supply current
- Wide V_{cc} operating range: 15 V to 30 V over temperature range
- Wide operating temperature range: -40°C to 110°C
- Regulatory Approvals
 - UL UL1577
 - VDE EN60747-5-5(VDE0884-5)
 - CQC GB4943.1, GB8898

Applications

- Isolated IGBT/Power MOSFET gate drive
- AC and brushless DC motor drives
- Industrial inverters and Uninterruptible Power Supply(UPS)

Internal Circuit





2.5A Output Smart Gate Driver Optocoupler

\sim	SOP16,	2.5A Outp	ut Smart (Gate Driver	Optocouple	
AB	SOLUTE M	AXIMUM F	RATINGS			
PARAMETER	SYMBOL	YMBOL MIN.		UNIT	NOTE	
Storage Temperature	T _{stg}	-55	125	°C		
Operating Temperature	T _A	-40	110	°C	2	
Output IC Junction Temperature	TJ	-	125	°C	2	
Average Forward Input Current	lF	-	20	mA	1	
Peak Transient Input Current (<1 µs pulse width, 300pps)	I _{F(TRAN)}	-	1.0	A		
Reverse Input Voltage	VR	-	5	V		
"High" Peak Output Current	IOH(PEAK)	-	2.5	A	3	
"Low" Peak Output Current	IOL(PEAK)	-	2.5	A	3	
Positive Input Supply Voltage	Vcc1	-0.5	7.0	V		
FAULT Output Current	IFAULT	-	8.0	mA		
FAULT Pin Voltage	VFAULT	-0.5	V _{CC1}	V		
Total Output Supply Volta	(Vcc2 - Vee)	-0.5	33	V		
Negative Output Supply Voltage	(V _E - V _{EE})	-0.5	15	V	6	
Positive Output Supply Voltage	(V _{CC2} - V _E)	-0.5	33-(VE-VEE)	V		
Gate Drive Output Voltage	V _{O(PEAK)}	-0.5	Vcc2	V		
Peak Clamping Sinking Current	I _{Clamp}	-	1.7	A		
Miller Clamping Pin Voltage	VClamp	-0.5	Vcc2	V		
DESAT Voltage	Vdesat	VE	V _E +10	V		
Output IC Power Dissipation	Po	-	600	mW	2	
Input IC Power Dissipation	Pı	-	150	mW	2	
Solder Reflow Temperature Profile	See Package Outline Drawings section					

RECOMMENDED OPERATION CONDITIONS							
PARAMETER	SYMBOL	MIN.	MAX.	UNIT	Note		
Operating Temperature	TA	-40	110	°C	2		
Total Output Supply Voltage	(V _{CC2} - V _{EE})	15	30	V	7		
Negative Output Supply Voltage	(V _E - V _{EE})	0	15	V	4		
Positive Output Supply Voltage	(V _{CC2} - V _E)	15	30-(V _E -V _{EE})	V			
Input Current (ON)	I _{F(ON)}	8	12	mA			
Input Voltage (OFF)	V _{F(OFF)}	-3.6	0.8	V			



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ELECTI	RICAL	OPTIC	CAL C	HAR	ACTE	RISTICS	
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITION	NOTE
	IN	PUT CH	ARACTE	ERISTIC	S		
FAULT Logic Low		-	0.01	0.4	V	I_{FAULT} = 1.1 mA, V_{CC1} = 5.5V	
Output Voltage	VFAULIL	-	0.02	0.4	V	$I_{FAULT} = 1.1 \text{ mA}, V_{CC1} = 3.3 \text{V}$	
FAULT Logic High	I	-	0.01	0.5	μA	$V_{FAULT} = 5.5 V, V_{CC1} = 5.5 V$	
Output Current	IFAULTH	-	0.006	0.3	μA	$V_{FAULT} = 3.3 V, V_{CC1} = 3.3 V$	
High Level	la	-	-2.0	-0.5	А	$V_0 = V_{CC2} - 4$	5
Output Current	ЮН	-	-	-2.0	А	$V_{\rm O}=V_{\rm CC2}-15$	3
Low Level	Le.	0.5	2.0	-	А	$V_{O} = V_{EE} + 2.5$	5
Output Current	IOL	2.0	-	-	А	Vo = V _{EE} + 15	3
Low Level Output Current		70	100	220	m۸		6
During Fault Condition	IOLF	70	100	250	ША	VOUT - $V_{EE} = 14 V$	0
High Level Output Voltage	V _{OH}	V _{cc} -0.5	V _{CC} -0.1	-	V	I _O = -650 μA	7,8,9,23
Low Level Output Voltage	Vol	-	0.1	0.5	V	l _o = 100 mA	
Clamp Pin Threshold Voltage	V _{tClamp}	-	2.2	-	V	-	
Clamp Low Level Sinking Current	Icl	0.35	1.0	-	А	$V_0 = V_{EE} + 2.5$	
High Level Supply Current	Ісс2н	-	2.23	5	mA	$I_0 = 0 \text{ mA}$	9
Low Level Supply Current	I _{CC2L}	-	2.36	5	mA	I _O = 0 mA	
Blanking Capacitor	1	0.12	0.24	0 22	m۸	$V_{\text{DECUT}} = 2 V_{\text{DECUT}}$	0.10
Charging Current	ICHG	0.15	-0.24	-0.33	ΜA	V DESAT = 2 V	9,10
Blanking Capacitor	Issaus	10	21	_	m۸		
Discharge Current	IDSCHG	10	51	-		VDESAT - 7.0 V	
DESAT Threshold	Vdesat	6	6.7	7.5	V	Vcc2 -VE >VUVLO-	9
	V _{UVLO+}	10.5	11.5	12.5	V	Vo > 5 V	7,9,11
	Vuvlo-	9.2	10.5	11.1	V	Vo < 5 V	7,9,12
	(Vuvlo+	0.4	1.0	_	V		
	- Vuvlo-)	0.4	1.0	-	V	-	
Threshold Input Current	leu u	_	0.27	Б	m۸	$l_0 = 0 \text{ m} \Lambda / l_0 > 5 / l_0$	
Low to High	IFLH	_	0.27	,	ША	10 = 0 mA, V0 > 0 V	
Threshold Input Voltage High to Low	V _{FHL}	0.8	1.74	-	V	-	
Input Forward Voltage	VF	1.6	2.0	2.4	V	IF = 10 mA	
Input Reverse Breakdown Voltage	BV_R	5	-	-	V	IR = 10 μA	
Input Capacitance	CIN	-	70	-	pF	f = 1 MHz, VF = 0 V	

Unless otherwise noted, all typical values at T_A = 25°C, V_{CC2} - V_{EE} = 30 V, V_{E} - V_{EE} = 0 V;

all Minimum/Maximum specifications are at Recommended Operating Conditions.

Release Date: 2024/10/15



$\mathbf{\omega}$	S	OP16	, 2.5	A Ou	ıtput	Smart Gate Driver Optoco	oupler
	SWITC	HIN	g Sp	ECIF	ICAT	TION	
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITION	NOTE
Propagation Delay Time	4	50	04	250			
to Output Low Level	IPHL	50	94	250	ns		
Propagation Delay Time	t	50	07	250	20		12.15
to Output High Level	UPLH	50	97	250	115	$Rg = 10 \Omega, Cg = 10 nF,$	13,15
Pulse Width Distortion	PWD	-100	-	100	ns	$I = IU K \Pi Z,$	14,17
Propagation Delay Difference	PDD	-150	_	150	ne	$L_{r} = 10 \text{ mA} \text{ V}_{000} = 30 \text{ V}$	17 16
Between Any Two Parts	(tphl - tplh)	-150	-	150	115	IF = 10 IIIA, VCC2 = 30 V	17,10
Rise Time	tr	-	22	-	ns		
Fall Time	t _f	-	14	-	ns		
DESAT Sense to 90%						$C_{\text{DESAT}} = 100 \text{pF}, \text{R}_{\text{F}}=2.1 \text{k}\Omega,$	
	t _{desat(90%)}	-	0.1	0.5	μs	Rg = 10 Ω, Cg = 10 nF,	19
						V _{CC2} = 30 V	
DESAT Sense to 10%	tdesat(10%)	-	2.3	3		$C_{\text{DESAT}} = 100 \text{pF}, \text{R}_{\text{F}}=2.1 \text{k}\Omega$,	
VO Delay					μs	Rg = 10 Ω, Cg = 10 nF,	
						Vcc2 = 30 V	
	tdesat(fault)	-				$C_{DESAT} = 100 \text{ pF}, \text{ R}_{F} = 2.1 \text{k}\Omega,$	- 18
			0.2	0.5	μs	$C_F = Open, Rg = 10 \Omega,$	
DESAT Sense to Low Level						Cg = 10 nF, V _{CC2} = 30 V	
FAULT Signal Delay				-		C_{DESAT} = 100 pF, R_{F} = 2.1k Ω ,	
					μs	$C_F = 1 \text{ nF}, \text{ Rg} = 10 \Omega,$	
						$Cg = 10 \text{ nF}, V_{CC2} = 30 \text{ V}$	
DESAT Sense to DESAT						$C_{DESAT} = 100 pF, R_F = 2.1 k\Omega,$	
Low Propagation Delay	tdesat(LOW)	-	0.15	-	μs	Rg = 10 Ω, Cg = 10 nF,	19
						Vcc2 = 30 V	
						$C_{DESAT} = 100 pF, R_F = 2.1 k\Omega,$	
DESAT Input Mute	tdesat(mute)	5	-	-	μs	Rg = 10 Ω, Cg = 10 nF,	20
						Vcc1 = 5.5V, Vcc2 = 30 V	
						C_{DESAT} = 100pF, RF = 2.1 k Ω ,	
RESET to High Level FAULT	treset(fault)	0.2	0.6	2.0	μs	Rg = 10 Ω, Cg = 10 nF,	
Signal Delay						$V_{CC1} = 5.5V, V_{CC2} = 30 V$	
						C _{DESAT} = 100pF, RF = 2.1 kΩ,	
RESET to High Level FAULT	treset(fault)	0.2	0.6	2.5	μs	Rg = 10 Ω, Cg = 10 nF,	
Signal Delay						V _{CC1} = 3.3V, V _{CC2} = 30 V	



	S	OP16	, 2.5	A Ou	tput	Smart Gate Driver Optoco	oupler
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITION	NOTE
		45				$T_A=25^{\circ}C$, $I_F=10mA$, $V_{CM}=1500$ V,	21
Output High Level Common	Dutput High Level Common IS - Mode Transient Immunity 50 -	10//00	V_{CC2} =30V, R _F =2.1k Ω , C _F =15 pF	21			
Mode Transient Immunity		50	-		κν/μs	A=25°С, I⊧=10mA ,V _{СМ} =1500 V,	21.26
				-		$V_{CC2}=30V, R_F=2.1k\Omega, C_F=1nF$	21,20
	Output Low Level Common	15				$T_A=25^{\circ}C, V_F=0V, V_{CM}=1500V,$	22
Output Low Level Common		-	10//00	V_{CC2} =30V, R _F =2.1k Ω , C _F =15 pF			
Mode Transient Immunity		50	-		κν/μs	T _A =25°C, V _F =0V, V _{CM} =1500V,	
		50		-		V _{CC2} =30V, R _F =2.1kΩ, C _F =1nF	

Unless otherwise noted, all typical values at $T_A = 25^{\circ}C$, $V_{CC2} - V_{EE} = 30$ V, $V_E - V_{EE} = 0$ V; all Minimum/Maximum specifications are at Recommended Operating Conditions.

ISOLATION CHARACTERISTIC							
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITION	NOTE
Withstand Insulation	Maria	5000	5000 -	-	V	RH ≤ 40%-60%,	24,25
Test Voltage	Viso	5000				t = 1min, T _A = 25 °C	
Input-Output			1012				25
Resistance	r ti-0	-	1012	-	12	VI-0 - 500V DC	25

Note1: Derate linearly above 70°C free air temperature at a rate of 0.3 mA/°C.

Note2: In order to achieve the absolute maximum power dissipation specified, pins 4, 9, and 10 require ground plane connections and may require airflow. See the Thermal Model section in the application notes at the end of this data sheet for details on how to estimate junction temperature and power dissipation. In most cases the absolute maximum output IC junction temperature is the limiting factor. The actual power dissipation achievable will depend on the application environment (PCB Layout, air flow, part placement, etc.). See the Recommended PCB Layout section in the application notes for layout considerations. Output IC power dissipation is derated linearly at 10 mW/°C above 90°C. Input IC power dissipation does not require derating.

Note3: Maximum pulse width = 10 μ s. This value is intended to allow for component tolerances for designs with IO peak minimum = 1.0 A. Derate linearly from 2.0 A at +25°C to 1.5 A at +105°C. This compensates for increased I_{OPEAK} due to changes in V_{OL} over temperature.

Note4: This supply is optional. Required only when negative gate drive is implemented.

Note5: Maximum pulse width = 50 μ s.

Note6: See the Slow IGBT Gate Discharge During Fault Condition section in the applications notes at the end of this data sheet for further details.



SOP16, 2.5A Output Smart Gate Driver Optocoupler

Note7: 15 V is the recommended minimum operating positive supply voltage ($V_{CC2} - V_E$) to ensure adequate margin in excess of the maximum V_{UVLO+} threshold of 12.5 V. For High Level Output Voltage testing, V_{OH} is measured with a dc load current. When driving capacitive loads, V_{OH} will approach V_{CC} as I_{OH} approaches zero units.

Note8: Maximum pulse width = 1.0 ms.

Note9: Once V_o of the MPCS-332J is allowed to go high (V_{CC2} - V_E > V_{UVLO+}), the DESAT detection feature of the MPCS-332J will be the primary source of IGBT protection. U_{VLO} is needed to ensure DESAT is functional. Once V_{CC2} is increased from 0V to above V_{UVLO+}, DESAT will remain functional until V_{CC2} is decreased below V_{UVLO-}. Thus, the DESAT detection and U_{VLO} features of the MPCS-332J work in conjunction to ensure constant IGBT protection.

Note10: See the DESAT fault detection blanking time section in the applications notes at the end of this data sheet for further details.

Note11: This is the "increasing" (i.e. turn-on or "positive going" direction) of V_{CC2} - V_E

Note12: This is the "decreasing" (i.e. turn-off or "negative going" direction) of V_{CC2}-V_E

Note13: This load condition approximates the gate load of a 1200 V/75A IGBT.

Note14: Pulse Width Distortion (PWD) is defined as $|t_{PHL} - t_{PLH}|$ for any given unit.

Note15: As measured from I_{F} to $V_{\text{O}}.$

Note16: The difference between t_{PHL} and t_{PLH} between any two MPCS-332J parts under the same test conditions.

Note17: As measured from ANODE, CATHODE of LED to $V_{\mbox{\scriptsize OUT.}}$

Note18: This is the amount of time from when the DESAT threshold is exceeded, until the FAULT output goes low.

Note19: This is the amount of time the DESAT threshold must be exceeded before V_{OUT} begins to go low, and the FAULT output to go low. This is supply voltage dependent.

Note20: Auto Reset: This is the amount of time when V_{OUT} will be asserted low after DESAT threshold is exceeded. See the Description of Operation (Auto Reset) topic in the application information section. Note21: Common mode transient immunity in the high state is the maximum tolerable dV_{CM}/dt of the common mode pulse, V_{CM} , to assure that the output will remain in the high state (i.e., $V_O > 15$ V or FAULT > 2 V).

Note22: Common mode transient immunity in the low state is the maximum tolerable dV_{CM}/dt of the common mode pulse, V_{CM} , to assure that the output will remain in a low state (i.e., $V_0 < 1.0$ V or FAULT < 0.8 V).

Note23: To clamp the output voltage at V_{CC} - 3 V_{BE} , a pull-down resistor between the output and VEE is recommended to sink a static current of 650 μ A while the output is high. See the Output Pull-Down Resistor section in the application notes at the end of this data sheet if an output pull-down resistor is not used.



SOP16, 2.5A Output Smart Gate Driver Optocoupler

Note24: In accordance with UL 1577, each optocoupler is proof tested by applying an insulation test voltage ≥ 6000 Vrms for 1 second. This test is performed before the 100% production test for partial discharge (method b) shown in IEC/EN/DIN EN 60747-5-5 Insulation Characteristic Table.

Note25: This is a two-terminal measurement: pins 1-8 are shorted together and pins 9-16 are shorted together.

Note26: Split resistors network with a ratio of 1:1 is needed at input LED1.





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SOP16, 2.5A Output Smart Gate Driver Optocoupler





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		SOP16, 2.5A Outp	out Smart Gate Driver Optocoupler					
	ORDERING	AND MARKING I	NFORMATION					
MARKING INFORMATION								
	MYYWW 332J TV	M YY WW 332, T or V	: Company Abbr. : Year date code : 2-digit work week J : Part Number H : Factory identification mark : VDE Identification(Option)					
ORDERING INFORMATION			LABEL INFORMATION					
MPCS-332J-ZV			盐光照明光電股份有限公司					
MPC – Company Abbr. S – Stack 332J – Part Number Z – Tape and Reel Option (T1/T2) V –VDE Option (V or None)			T No : XXXXXXXXXXXX Bin Code : X No : XXXXXXXXXXXX te Code : XXXX y : XXXX pcs					
		PACKING QUANTI	Υ					
Option	Quantity	Quantity – Inner box	Quantity – Outer box					
T1/T2	1000 Units/Reel	2 Reels/Inner box	5 Inner box/Outer box = 10k Units					





8 minutes max.

6 minutes max.

Time 25°C to Peak Temperature







SOP16, 2.5A Output Smart Gate Driver Optocoupler DISCLAIMER

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- This product is not intended to be used for military, aircraft, medical, life sustaining or lifesaving applications or any other application which can result in human injury or death.
- Please contact WISELITE sales agent for special application request.
- Immerge unit's body in solder paste is not recommended.
- Parameters provided in datasheets may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated in each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify WISELITE's terms and conditions of purchase, including but not limited to the warranty expressed therein.
- Discoloration might be occurred on the package surface after soldering, reflow or long-time use. It neither impacts the performance nor reliability.